



SURFACE MOUNT DATALINE PROTECTION DEVICE

Features

- 300W Peak Pulse Power (tp = 8×20µs)
- Transient Protection for Data Line to IEC61000-4-2 Level 4 (ESD), 8kV HBM

Contact: Discharge - ±30kV Air: Discharge - ±30kV

- IEC 61000-4-4 (EFT)
- Low Leakage Current
- Surface Mount Package Ideally Suited for Automated Insertion
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

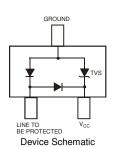
Mechanical Data

- Case: SOT-23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 Leadframe).
- Terminal Connections: See Diagram
- Marking Information: See Page 1
- Ordering Information: See Page 1
- Weight: 0.008 grams (Approximate)





Top View



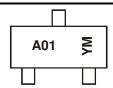
Ordering Information (Note 4)

Part Number	Case	Packaging
DLPT05-7-F	SOT23	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds
- 4. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



A01 = Product Type Marking Code

YM = Date Code Marking Y = Year (ex: G = 2019)

M = Month (ex: 9 = September)

Date Code Key

Year	1998	1999	2000	2001	 2019	2020	2021	2022
Code	J	K	L	М	 G	Н	I	J

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

Notes: 5. Product manufactured with Data Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb₂O₃ Fire Retardants.



Maximum Ratings @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Pulse Power (tp = 8×20μs, per Figure 2)	P _{PK}	300	W
Peak Forward Voltage (IPP = 1A, tp = 8×20µs, per Figure 2)	V_{FP}	2.1	V
Diode Peak Repetitive Reverse Voltage	V_{RRM}	75	V

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Ambient (Note 10)	$R_{\Theta JA}$	417	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

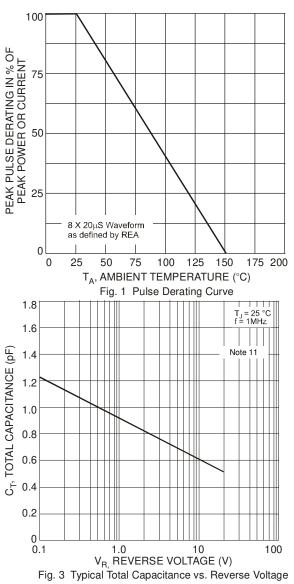
Electrical Characteristics @TA = 25°C unless otherwise specified

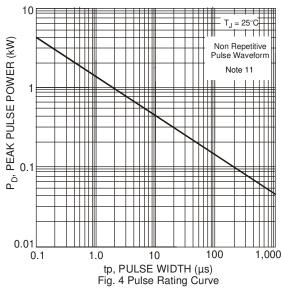
Reverse Standoff Voltage		n Voltage @ I _T	Test Current	Max. Reverse Leakage @ V _{RWM} (Note 9)	Max. Clamping Voltage @ I _{pp} = 1A (Note 8)	Typical Peak Pulse Current (Note 7)	Typical Total Capacitance (Note 6)
V _{RWM} (V)	Min (V)	Max (V)	I _T (mA)	I _R (μ A)	V _C (V)	(A)	(pF)
5	6.0	_	1.0	20	9.8	17	1.9

Notes:

- 6. $V_R = 0V$, f = 1MHz from line to be protected to ground pin.
- 7. tp = $8\times20\mu s$. 8. Clamping voltage value is based on an $8\times20\mu s$ peak pulse current (I_{pp}) waveform.
- 9. Short duration pulse test used to minimize self-heating effect.
 10. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at



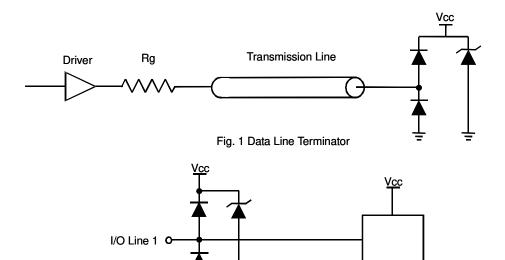




Notes: 11. Measured from line to be protected to ground pin.



Typical Application Schematics



I/O Line 2 o-

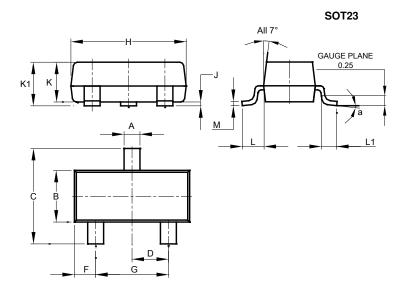
Fig. 2 Data Line Protection

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Package Outline Dimensions

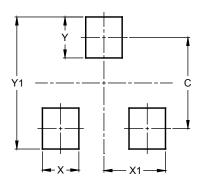
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23								
Dim	Min	Max	Тур					
Α	0.37	0.51	0.40					
В	1.20	1.40	1.30					
С	2.30	2.50	2.40					
D	0.89	1.03	0.915					
F	0.45	0.60	0.535					
G	1.78	2.05	1.83					
Н	2.80	3.00	2.90					
J	0.013	0.10	0.05					
K	0.890	1.00	0.975					
K1	0.903	1.10	1.025					
L	0.45	0.61	0.55					
L1	0.25	0.55	0.40					
М	0.085	0.150	0.110					
а	0°	8°						
All Dimensions in mm								

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23

Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Υ	0.9
V1	29



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